CLASSIFICATION PRO	ODUCT SPECIF	ICATION	No. DS-17xx-2400-1	02	REV. 1.9				
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	PANASONIC'S (ENW89820AxKF /		DATE	05.08.20)13				
Specification for Production									
Applicant / Manufacturer Hardware	Panasonic Inc Zeppelinstras 21337 Lünebu Germany		urope GmbH						
Applicant / Manufacturer Software	Please refer to Software Vers	o chapter 25 / 25.1 sions	Information rega	rding					
Software Version	Please refer to Software Vers	o chapter 25 / 25.1 sions	Information rega	rding					
Bluetooth QDL ID		ign Listing (QDL) I Sub-System Listin		eries.					
By purchase of any of products described in this document the customer accepts the document's validity and declares their agreement and understanding of its contents and recommendations. Panasonic reserves the right to make changes as required without notification.									
Power Electronics R&D C Wireless Connectivity Panasonic Industrial Devices Eu	/	APPROVED genehmigt	CHECKED geprüft		GNED stellt				

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1. SCOPE OF THIS DOCUME	NT			
	es to Panasonic's, Class 2, Bluetooth® ¹ k <u>540 from Texas Instruments</u>) and PAN17			ule,
2. DIFFERENCE PAN1720 / P	AN1721			
Both the PAN1720 and PAN17	21 are refered to as the PAN172x in this of	document.		
communication interface on the PAN1720. Compared to the PA	e with the PAN1720, with the exception th PAN1720 and I2C is the hardware comm N1720, the PAN1721 provides lower RF ce found on the PAN1720, and provides lo	nunication int current consi	terface on the umption. The PA	
Additional details , which have Instruments.	an impact on the module can be found in	the datashee	ts from Texas	
CC2540 from Texas Instrumen	<u>ts</u>			
CC2541 from Texas Instrumen	<u>ts</u>			
Both ICs the CC2540 as well a	s the CC2541 come with an internal 256 k	<b flash="" merr<="" td=""><td>iory.</td><td></td>	iory.	
3. DIFFERENCE PAN172X / P	2AN171X			
The PAN171x are the non ante	enna version where the PAN172x are the	versions with	antenna.	
4. KEY FEATURES				
Bluetooth Low Energ				
Surface mount type 1	5.6 x 8.7 x 1.8 mm ³ wer (typical) with transmit power cont	rol		
 Up to 4.0 dBm 1x por CC2541 has typically 		101		
High sensitivity (-94 c	•			
	C2540/CC2541 Single Chip BLE Sol	ution inside		
 High performance low No external component 	v power 8051 Microcontroller core			
 Fast Connection Setu 				
 Internal crystal oscilla 	•			
-	l oscillator for Sleep Timer			
 Two powerful USART USB or I2C interface 	S			
 USB or I2C interface Powerful five channe 	I DMA			
¹ Bluetooth is a registered trade	mark of the Bluetooth Special Interest Gro	oup.		

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Latest Profiles included e.g. Battery Monitor and Temperature sensor Integrated shielding to resist EMI ٠

•

Manufactured in conformance with RoHS •

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5. BLUETOOTH LOW ENERGY

Bluetooth Low Energy (BLE), part of Bluetooth Ver. 4.0, specifies two types of implementation: Single mode and dual mode. Single mode devices implement the low energy specification and consume just a fraction of the power of classic Bluetooth, allowing the short-range wireless standard to extend to coin cell battery applications for the first time. Dual mode devices combine low energy with the power of classic Bluetooth and are likely to become a de facto feature in almost all new Bluetooth enabled cellular phones and computers.

Single mode Bluetooth 4.0 Low Energy is not backwards compatible with previous Bluetooth standards. Dual mode Bluetooth 4.0 Low Energy is backwards compatible and well suited for gateway applications, but is not practical for low power devices.



6. APPLICATIONS FOR THE MODULE

All Embedded Wireless Applications

- Access Points
- Industrial Control
- Medical
- Scanners
- Wireless Sensors
- Low Power

- Proximity
- Smart Phone
- Access Points
- Temperature
- Wellness
- Sports

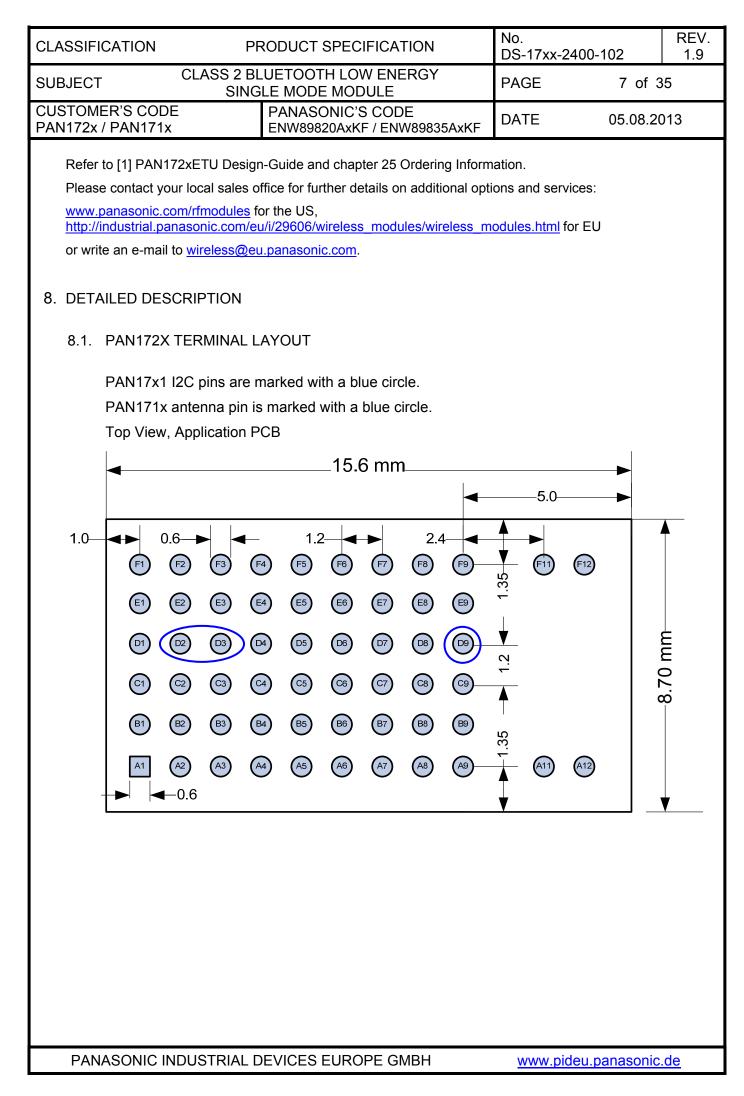
7. DESCRIPTION FOR THE MODULE

The PAN172x is a short-range, Class 2, BLE single mode module for implementing Bluetooth functionality into various electronic devices. A block diagram can be found in chapter 10.

The PAN172x is a cost-effective, low-power, true system-on-chip (SoC) for Bluetooth low energy applications. It enables robust BLE master or slave nodes to be built with very low total bill-of-material costs. The PAN172x combines an excellent RF transceiver with an industry-standard enhanced 8051 MCU, insystem programmable flash memory, 8-KB RAM, and many other powerful supporting features and peripherals. The PAN172x is suitable for systems where very low power consumption is required. Very low-power sleep modes are available. Short transition times between operating modes further enable low power consumption.

Panasonic offers Bluetooth low energy protocol stacks and applications from Texas Instruments and BlueRadios. The Bluetooth low energy protocol stack from Texas Instruments, is a flexible and cost-effective single-mode Bluetooth low energy solution.

The BlueRadios stack enables rapid and low cost development using an AT command set without the need for a complier. Additional advantages include UART programming, over-the-air-updates, easy integration "C" library framework, serial streaming of data, and smart phone libraries and applications.



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No	Pin Name	Pin Type	Description
A1	GND	Ground Pin	Connect to Ground
A2	P1.0	Digital I/O	Port 1.0 – 20mA drive capability
A3	Reset	Digital Input	Reset, active-low
A4	VCC	Power	2V – 3.6V analog/digital power supply connection
A5	VCC	Power	2V – 3.6V analog/digital power supply connection
A6	VCC	Power	2V – 3.6V analog/digital power supply connection
A7	GND	Ground Pin	Connect to Ground
A8	NC		Not Connected
A9	GND	Ground Pin	Connect to Ground
A11	GND	Ground Pin	Connect to Ground
A12	GND	Ground Pin	Connect to Ground
B1	P1.3	Digital I/O	Port 1.3
B2	P1.2	Digital I/O	Port 1.2
B3	P1.1	Digital I/O	Port 1.1 – 20mA drive capability
B4	P0.6	Digital I/O	Port 0.6
B5	NC	Digital I/O	Not Connected
	P0.1	Digital I/O	
B6 B7	P0.1 P0.0	Digital I/O Digital I/O	Port 0.1
			Port 0.0
B8	NC		Not Connected
B9	NC		Not Connected
C1	NC		Not Connected
C2	P1.4	Digital I/O	Port 1.4 / BR-SW UART CTS
C3	P1.5	Digital I/O	Port 1.5 / BR-SW UART RTS
C4	P0.7	Digital I/O	Port 0.7
C5	NC		Not Connected
C6	NC		Not Connected
C7	NC		Not Connected
C8	GND	Ground Pin	Connect to Ground
C9	GND	Ground Pin	Connect to Ground
D1	DVDD_USB	Power (digital)	2V – 3.6V digital power supply connection
D2	USB_N	Digital I/O	USB N / PAN17x1 I2C SDA // Leave floating if not used
D3	USB_P	Digital I/O	USB P / PAN17x1 I2C SCL // Leave floating if not used
D4	NC		Not Connected
D5	NC		Not Connected
D6	NC		Not Connected
D7	GND	Ground Pin	Connect to Ground
D8	GND	Ground Pin	Connect to Ground
D9	NC/RF		PAN172x Not Connected/50 ohm RF_Out PAN171x
E1	P2.1/DD	Digital I/O	Port 2.1 / Programming Interface DD
E2	P2.2/DC	Digital I/O	Port 2.2 / Programming Interface DC
E3	DGND USB	Ground Pin	Connect to Ground
E4	NC		Not Connected
E5	NC		Not Connected
E6	P0.2/RX/MISO	Digital I/O	Port 0.2 / TI-SW UART RX / SPI MISO
E7	NC		Not Connected
E8	GND	Ground Pin	Connect to Ground
E9	GND	Ground Pin	Connect to Ground
F1	GND	Ground Pin	Connect to Ground
F2	P1.6	Digital I/O	Port 1.6 / BR-SW UART TX
F3	P1.7	Digital I/O	Port 1.7 / BR-SW UART RX
F3 F4	P2.0	Digital I/O	Port 2.0
	P2.0 P0.4/CTS/CS	0	
F5		Digital I/O	Port 0.4 / TI-SW UART CTS / SPI CS
F6	NC	Disitel I/O	
F7	P0.3/TX/MOSI	Digital I/O	Port 0.3 / TI-SW UART TX /SPI MOSI
F8	P0.5/RTS/CLK	Digital I/O	Port 0.5 / TI-SW UART RTS /SPI CLK
F9	GND	Ground Pin	Connect to Ground
F11	GND	Ground Pin	Connect to Ground
F12	GND	Ground Pin	Connect to Ground

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8.2. CROSSREFERENCE GPIO PAN-MODULE TO BLUERADIOS-MODULE

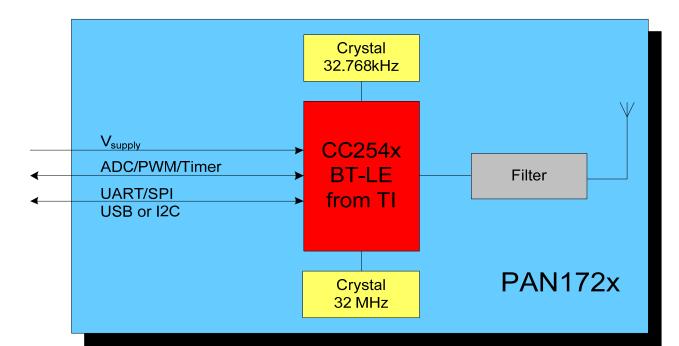
PAN	PAN17xx-BR		Radios
No	Pin Name	No	Pin Name
B7	P0.0	21	ADC_0
B6	P0.1	4	ADC_1
E6	P0.2 / MISO	5	SPI_MISO
F7	P0.3 / MOSI	8	SPI_MOSI
F5	P0.4 / CS	6	SPI_CSB
F8	P0.5 / CLK	7	SPI_CLK
B4	P0.6	26	PIO_3
C4	P0.7	25	PIO_6
A2	P1.0 GPIO	23	PIO_2
B3	P1.1 GPIO	24	PIO_5
B2	P1.2 GPIO	27	PIO_8
B1	P1.3 GPIO	22	PIO_9
C2	P1.4 / UART CTS	11	UART_CTS
C3	P1.5 / UART RTS	12	UART_RTS
F2	P1.6 GPIO / UART TXD	13	UART_TX
F3	P1.7 GPIO / UART RXD	14	UART_RX
F4	P2.0 GPIO	19	PIO_14
E1	P2.1 / DD	28	PIO_4
E2	P2.2 / DC	29	PIO_7

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9. BLUETOOTH FEATURES

- Bluetooth 4.0 single mode low energy technology.
- Class 2 TX power w/o external PA, improving link robustness.
- Excellent link budget (up to 96 dB), enabling long-range applications.
- Accurate digital received signal-strength indicator (RSSI)
- Integrates the new low power profiles and services
- Embedded BT-Stack available

10. PAN172X BLOCK DIAGRAM



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11. TEST CONDITIONS

Measurements shall be made under operating free-air temperature range unless otherwise specified.

Temperature	25 ± 10°C
Humidity	40 to 85%RH
Supply Voltage	3.3V

12. GENERAL DEVICE REQUIREMENTS AND OPERATION

All specifications are over temperature and process, unless indicated otherwise.

12.1. ABSOLUTE MAXIMUM RATINGS

No	See ²		Value	Unit
Rati	ings Over Operatii			
1	Supply voltage	All supply pins must have the same voltage	-0.3 to 3.9	V
2	Voltage on any o	ligital pin	-0.3 to VDD+0.3 <3,9	V
3	Operating ambie	nt temperature range	-40 to 85	°C
4	Storage tempera	iture range	-40 to 125	°C
5	Bluetooth RF inp	outs	10	dBm
6		ng to human-body model, JEDEC STD 22, method A114 Irged-device model, JEDEC STD 22, method C101	1000 500	v

12.2. RECOMMENDED OPERATING CONDITIONS

No	Rating	Min	Max	Unit
1	Power supply voltage	2	3.6	V
2	Maximum ambient operating temperature	-40	85	°C

² Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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12.3. PAN1720 CURRENT CONSUMPTION

The current consumption is dependant on the user scenario and the setup and timing in the low power modes. The total power consumption can be optimized by adjusting the scan windows and intervals.

Please refer for the latest information for different power modes to the chapter "Electrical Characteristics" in Texas Instruments datasheet, refer to [2]. As indication below are typical values from CC2540 datasheet.

For PAN1721 refer to CC2541 datasheet.

ELECTRICAL CHARACTERISTICS

Measured on Texas Instruments CC2540 EM reference design with T_A = 25°C and VDD = 3 V

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
I _{core}		Power mode 1. Digital regulator on; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, BOD and sleep timer active; RAM and register retention		235		
	Core current consumption	Power mode 2. Digital regulator off; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and sleep timer active; RAM and register retention		0.9		μA
		Power mode 3. Digital regulator off; no clocks; POR active; RAM and register retention	0.4			
		Low MCU activity: 32-MHz XOSC running. No radio or peripherals. No flash access, no RAM access.		6.7		mA
		Timer 1. Timer running, 32-MHz XOSC used		90		μA
		Timer 2. Timer running, 32-MHz XOSC used		90		μA
	Peripheral current consumption	Timer 3. Timer running, 32-MHz XOSC used		60		μA
Iperi	(Adds to core current I _{core} for each peripheral unit activated)	Timer 4. Timer running, 32-MHz XOSC used		70		μA
	,	Sleep timer, including 32.753-kHz RCOSC		0.6		μA
		ADC, when converting		1.2		mA

GENERAL CHARACTERISTICS

Measured on Texas Instruments CC2540 EM reference design with T_A = 25°C and VDD = 3 V

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
WAKE-UP AND TIMING	·				
Power mode 1 \rightarrow Active	Digital regulator on, 16-MHz RCOSC and 32-MHz crystal oscillator off. Start-up of 16-MHz RCOSC		4		μs
Power mode 2 or $3 \rightarrow \text{Active}$	Digital regulator off, 16-MHz RCOSC and 32-MHz crystal oscillator off. Start-up of regulator and 16-MHz RCOSC		120		μs
Active \rightarrow TX or RX	Crystal ESR = 16 $\Omega.$ Initially running on 16-MHz RCOSC, with 32-MHz XOSC OFF		410		μs
	With 32-MHz XOSC initially on		160		μs
RX/TX turnaround			150		μs
RADIO PART	•				
RF frequency range	Programmable in 2-MHz steps	2402		2480	MHz
Data rate and modulation format	1 Mbps, GFSK, 250 kHz deviation			•	

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13. BLUETOOTH RF PERFORMANCE

13.1. PAN1720 BLUETOOTH CHARACTERISTICS

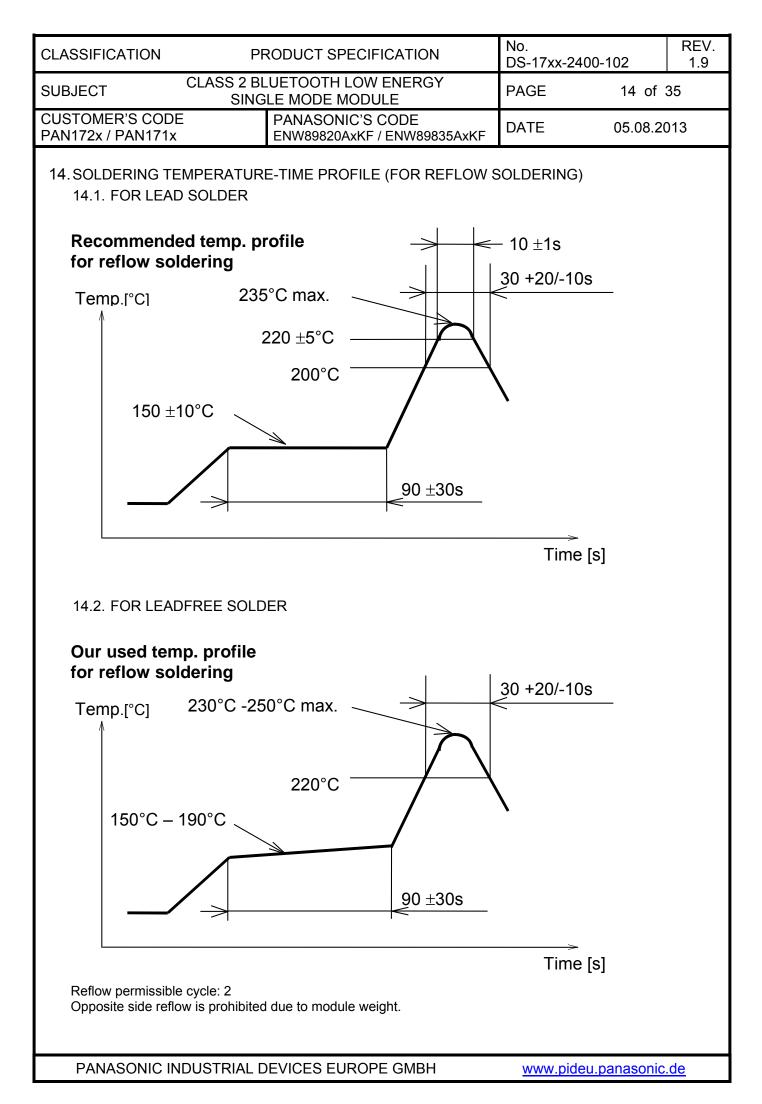
No	Characteristics	Condition	Min	Тур	Max	BT Spec	Unit
1	Operation frequency range		2402		2480		MHz
2	Channel spacing			2			MHz
	Output Power	Maximum setting, measured at single ended 500hm.		4			dBm
3	3 Output Power	Minimum setting, measured at single ended 500hm.		-24			dBm
4	Sensitivity, High Cain Made	High-gain mode		-93.0		-70	dBm
4	Sensitivity, High Gain Mode	Standard mode		-92.5		-70	

13.2. PAN1721 BLUETOOTH CHARACTERISTICS

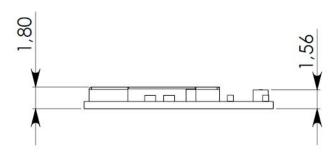
No	Characteristics	Condition	Min	Тур	Max	BT Spec	Unit	
1	Operation frequency range		2402		2480		MHz	
2	Channel spacing			2			MHz	
3	Output Power	Maximum setting, measured at single ended 500hm.		0			dBm	
3		Minimum setting, measured at single ended 500hm.		-24			dBm	
4	Consitivity Lligh Cain Made	High-gain mode		-93.0		-70	dDm	
4	Sensitivity, High Gain Mode	Standard mode		-92.5		-70	dBm	

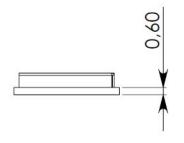
13.3. PAN17XX SPURIOUS EMISSION

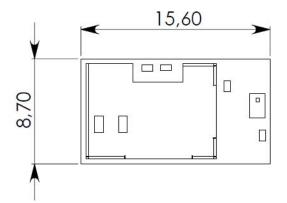
No	Characteristics	Condition	Тур	Max	Unit
1	Spurious emissions	Conducted measurement with a $50-\Omega$ single-ended load. Complies with EN 300 328, EN 300 440 class 2, FCC CFR47, Part 15 and ARIB STD-T-66		-41	dBm

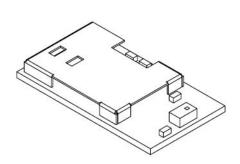


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15. PAN1	72X MODULI	E DIMENS	ION				
No.	Item	Dime	ension	Tolerance	Remark		
1	Width	8.70		± 0.20			
2	Length	15.60)	± 0.20			
3	Height	1.80		± 0.20	With case		



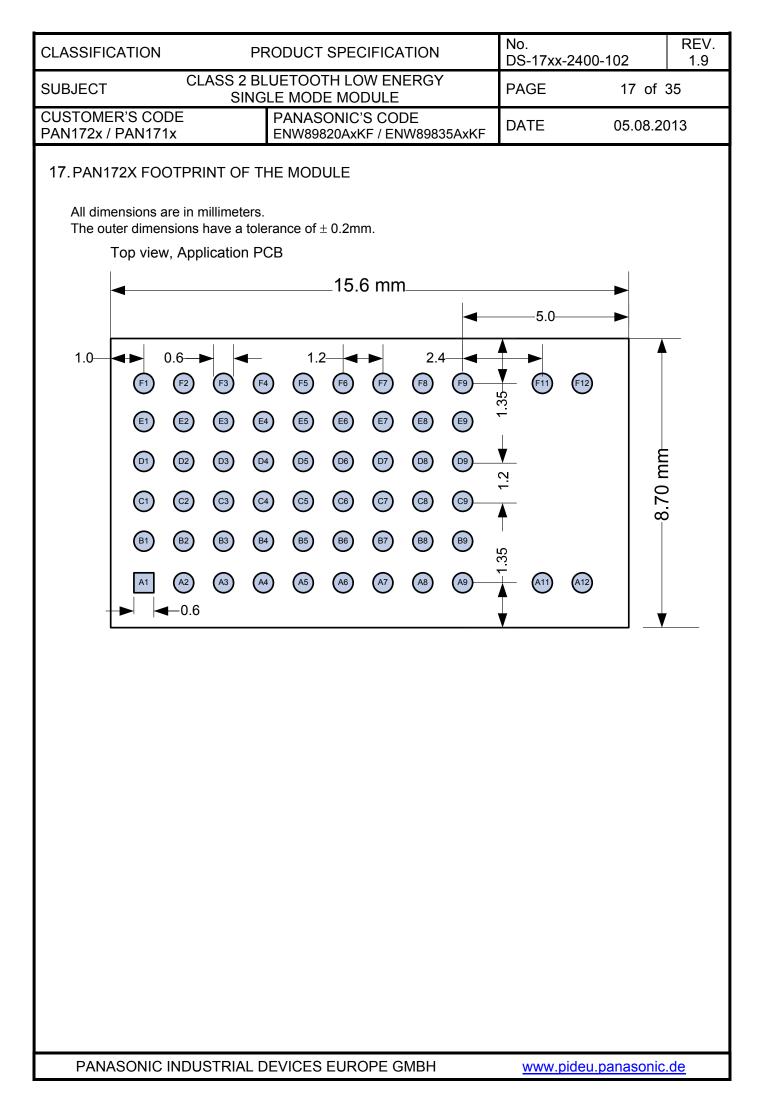






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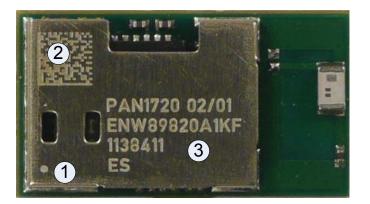
				■	
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CUSTOME PAN172x /	ER'S CODE / PAN171x	PANASO	NIC'S CODE)AxKF / ENW89835AxKF	DATE 05.	08.2013
16.PAN1	71X MODULE D	IMENSION			
No.	Item	Dimension	Tolerance	Remark	
1	Width	8.70	± 0.20		
2	Length	11.60	± 0.20		
3	Height	1.80	± 0.20	With case	
8 ,7			BZ		



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18. PAN171X FOOTPRINT OF T All dimensions are in millimeters. The outer dimensions have a tole Top view, Application P	HE MODULE erance of \pm 0.2mm.		
	(F4) (F5) (F6) (F7) (F8) (F9) (G) (G)	■ 1.35 ■ 1.2 ■ 1.35	
PANASONIC INDUSTRIAL E	DEVICES EUROPE GMBH	www.pideu.panasonic	.de

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19. CASE MARKING



No.	Remark
1	Marking for Pin 1 (Circle 0,15 mm)
2	2D-Code, for internal usage only and can be change without any notice
3	Marking definition see below

19.1. EXAMPLE FOR MARKING

Ρ	Α	Ν	1	7	2	0			Η	W	/	S	W		
Е	Ν	W	8	9	8	2	0	Α	Х	Κ	F				
Υ	Υ	W	W	D	L	L									
F	С	С		D	:		Т	7	V	Ρ	Α	Ν	1	7	

19.2. MARKING DEFINITION

- (1) Pin1 marking
- (2) 2D code (Serial number)
- (3) Marking:
 - PAN17xx (Model Name), HW/SW (Hardware/Software version)
 - ENW89820AxKF (Part Number, refer to chapter 25 Ordering Information)
 - Lot code (YearYear, WeekWeek, Day, LotLot)
 - ES (Engineering Sample marking)

Note: For available Software Versions, refer to [1] PAN172xETU Design-Guide. and chapter 25 Ordering Information.

20. MECHANICAL REQUIREMENTS

No.	Item	Limit	Condition
1	Solderability	More than 75% of the soldering area shall be coated by solder	Reflow soldering with recommendable temperature profile
2	Resistance to soldering heat	It shall be satisfied electrical requirements and not be mechanical damage	See chapter 14.2

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SUBJECT	θY	PAGE	20 of 3	35			
CUSTOMER'S PAN172x / PA		PANASONIC'S CODE ENW89820AxKF / ENW89	835AxKF	DATE	05.08.20	013	
21. DEVELO	PMENT OF APPLIC	CATIONS					
For develo	opment support please	e refer to [1] PAN172xETU Do	esign-Guide				
22. RELIABII	LITY TESTS						
The measurement should be done after being exposed to room temperature and humidity for 1 hour.							
No. Item Limit Condition							

INO.	item		Sonation
1	Vibration test	Electrical parameter should be in specification	a) Freq.:10~50Hz,Amplitude:1.5mm a) 20min. / cycle,1hrs. each of XYZ axis b) Freq.:30~100Hz, 6G b) 20min. / cycle,1hrs. each of XYZ axis
2	Shock test	the same as above	Dropped onto hard wood from height of 50cm for 3 times
3	Heat cycle test	the same as above	-40°C for 30min. and +85°C for 30min.; each temperature 300 cycles
4	Moisture test	the same as above	+60°C, 90% RH, 300h
5	Low temp. test	the same as above	-40°C, 300h
6	High temp. test	the same as above	+85°C, 300h

23. CAUTIONS

Failure to follow the guidelines set forth in this document may result in degrading of the product's functions and damage to the product.

23.1. DESIGN NOTES

- (1) Follow the conditions written in this specification, especially the control signals of this module.
- (2) The supply voltage has to be free of AC ripple voltage (for example from a battery or a low noise regulator output). For noisy supply voltages, provide a decoupling circuit (for example a ferrite in series connection and a bypass capacitor to ground of at least 47uF directly at the module).
- (3) This product should not be mechanically stressed when installed.
- (4) Keep this product away from heat. Heat is the major cause of decreasing the life of these products.
- (5) Avoid assembly and use of the target equipment in conditions where the products' temperature may exceed the maximum tolerance.
- (6) The supply voltage should not be exceedingly high or reversed. It should not carry noise and/or spikes.
- (7) Keep this product away from other high frequency circuits.

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23.2. INSTALLATION NOTES

- Reflow soldering is possible twice based on the conditions in chapter 15. Set up the temperature at the soldering portion of this product according to this reflow profile.
- (2) Carefully position the products so that their heat will not burn into printed circuit boards or affect the other components that are susceptible to heat.
- (3) Carefully locate these products so that their temperatures will not increase due to the effects of heat generated by neighboring components.
- (4) If a vinyl-covered wire comes into contact with the products, then the cover will melt and generate toxic gas, damaging the insulation. Never allow contact between the cover and these products to occur.
- (5) This product should not be mechanically stressed or vibrated when reflowed.
- (6) To repair the board by hand soldering, follow the conditions set forth in this chapter.
- (7) Do not wash this product.
- (8) Refer to the recommended pattern when designing a board.
- (9) Pressing on parts of the metal cover or fastening objects to the metal will cause damage to the unit.
- (10) For more details on LGA (Land Grid Arrey) soldering processes refer to the application note.

23.3. USAGE CONDITIONS NOTES

- (1) Take measures to protect the unit against static electricity. If pulses or other transient loads (a large load applied in a short time) are applied to the products, check and evaluate their operation befor assembly on the final products.
- (2) Do not use dropped products.
- (3) Do not touch, damage or soil the pins.
- (4) Follow the recommended condition ratings about the power supply applied to this product.
- (5) Electrode peeling strength: Do not add pressure of more than 4.9N when soldered on PCB.
- (6) Pressing on parts of the metal cover or fastening objects to the metal cover will cause damage.
- (7) These products are intended for general purpose and standard use in general electronic equipment, such as home appliances, office equipment, information and communication equipment.

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CUSTOMER'S C PAN172x / PAN1		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	05.08.20)13
23.4. STOR	RAGE NOTES				
(2) [c • • • • • • • • • • • • • • • • • •	 Do not store these characteristics of t Storage in salty such as Cl2, H2 Storage in direct Storage in an ento 35°C range, c Storage of the pperiod: Please cafter 6 months c Keep this product shou 	nvironment where the temperature or where the humidity may be outsi products for more than one year after check the adhesive strength of the o	ns or the performa- ice will be adverse in concentration of may be outside the ide the 45 to 85% ter the date of deli embossed tape a and corrosive gas. n transported.	ely affecte of corrosiv he range range. livery Stor and solder	ve gas, of 5°C rage
23.5. SAFE	TY CAUTIONS				
	specifications are lual components.	e intended to preserve the quality as	surance of produc	cts and	
these s circuit. when a (1) E p (2) E	specifications, with . If electrical shock a short circuit occu Ensure the safety protection device. Ensure the safety	evaluate the operation when mounte hout deviation when using the products, smoke, fire, and/or accidents invo- urs, then provide the following fails of the whole system by installing a to f the whole system by installing a t a single fault causing an unsafe sta	ucts. These produ- olving human life afe functions, as a protection circuit redundant circuit	icts may s are anticij minimum t and a	short- pated
	ER CAUTIONS	a single laur causing an ansars of	alus.		
(2) F (3) E a t (4) T	Please do not use Be sure to provide additional damage the product.	sheet is copyrighted. Please do not the products for other purposes that an appropriate fail-safe function of that may be caused by the abnorn been manufactured without any ozo ocol.	nan those listed. In your product to mal function or the	prevent a e failure o	an of
(5) T c c	These products ar conditions shown conditions, check	re not intended for other uses, other below. Before using these products their performance and reliability un nine whether or not they can be use	s under such spea nder the said spec	cial cial condit	ions

- In liquid, such as water, salt water, oil, alkali, or organic solvent, or in places where liquid may splash.
- In direct sunlight, outdoors, or in a dusty environment
- In an environment where condensation occurs.
- In an environment with a high concentration of harmful gas (e.g. salty air, HCl,

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Cl2, SO2, H2S, NH3, and NOX)

(6) If an abnormal voltage is applied due to a problem occurring in other components or circuits, replace these products with new products because they may not be able to provide normal performance even if their electronic characteristics and appearances appear satisfactory.

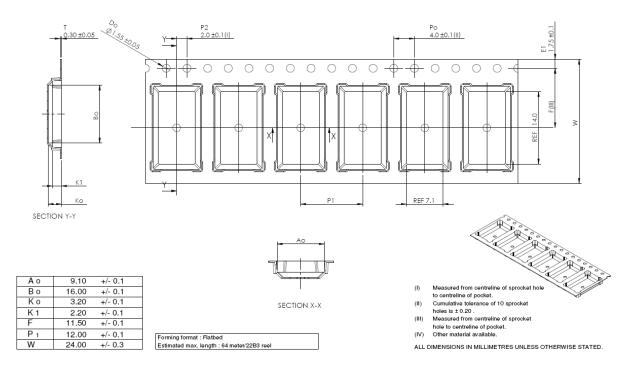
(7) When you have any question or uncertainty, contact Panasonic.

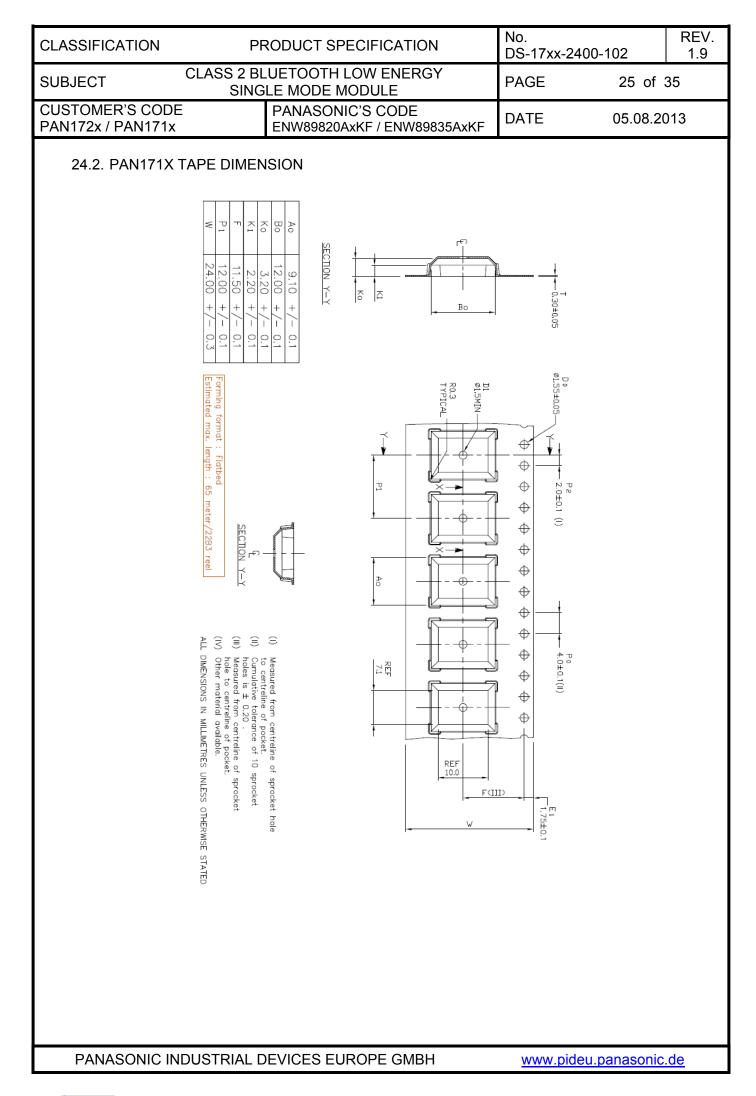
CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-17xx-2400-	-102	REV. 1.9
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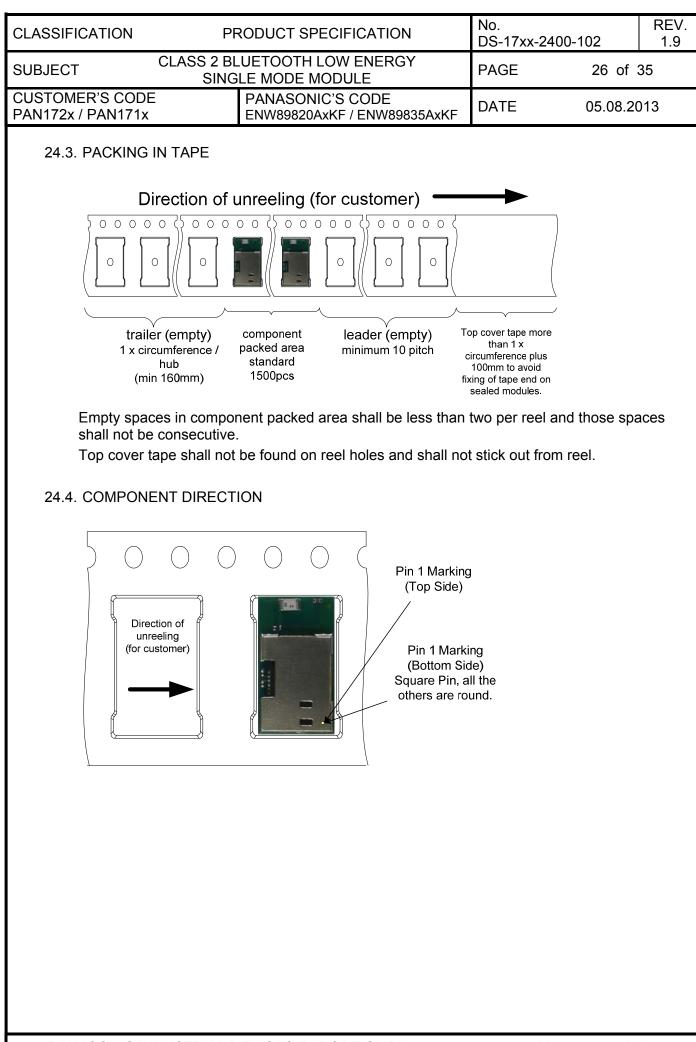
24. PACKAGING

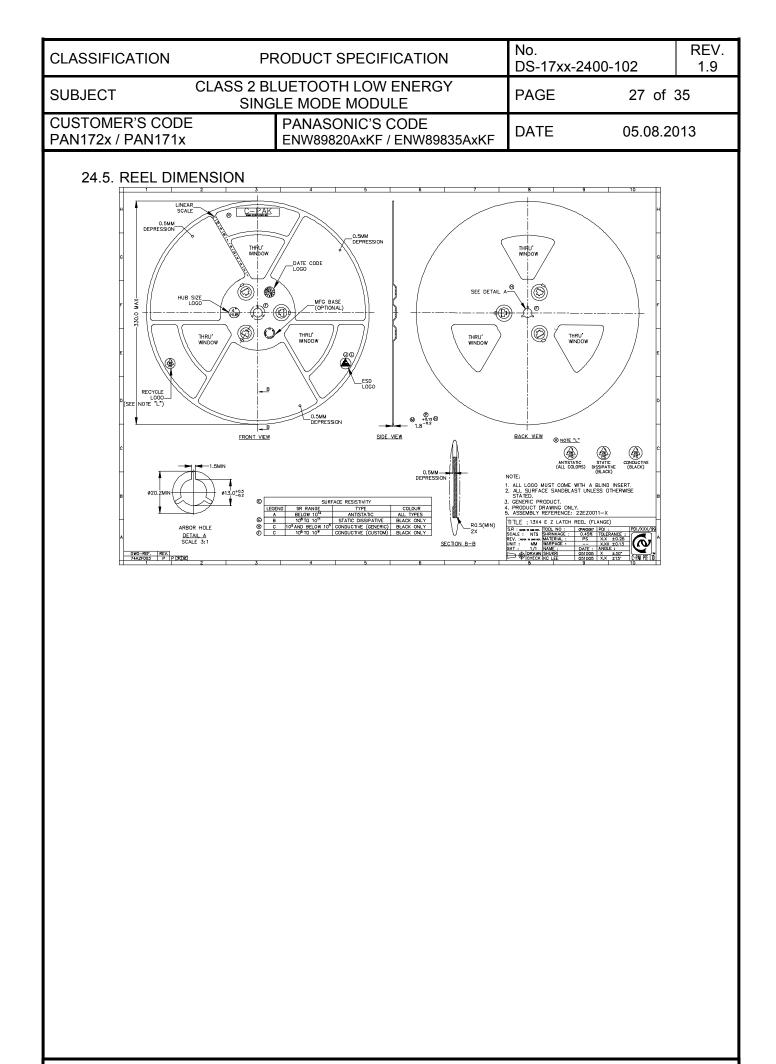
If the product has mass production status, indicated in chapter 27, we will deliver the module in the package which are described below.

24.1. PAN172X TAPE DIMENSION

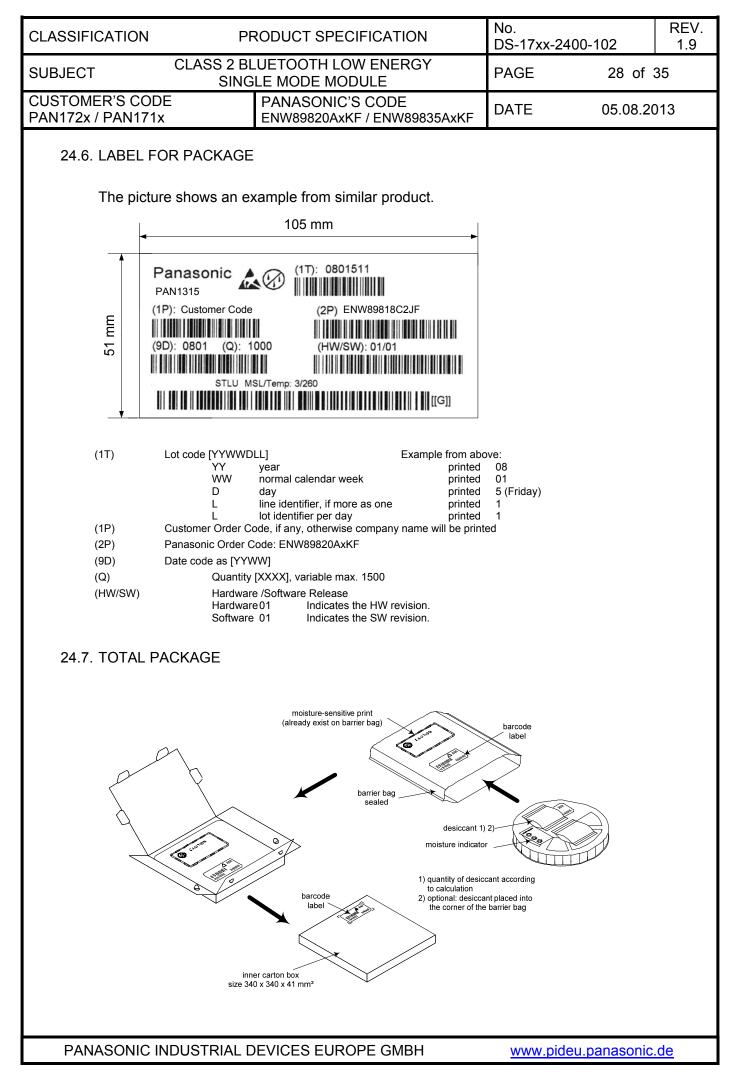








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25. ORDERING INFORMATION

Ordering part number	Description	MOQ ⁽¹⁾
	PAN1720	
ENW89820A1KF (2)	CLASS 2 Bluetooth single mode Module according BT-4.0.	1500
	Bluetooth® smart device	
	PAN1720	
ENW89820A3KF (2)	Same as above including BlueRadios BR-SPP FW version.	1500
	Bluetooth® smart device	
ENW89835A1KF (2)	PAN1721	
	CLASS 2 Bluetooth single mode Module according BT-4.0.	1500
	Bluetooth® smart device	
	PAN1721	
ENW89835A3KF ⁽²⁾	Same as above including BlueRadios BR-SPP FW version.	1500
	Bluetooth® smart device	
	PAN1711	
ENW89835C1KF	CLASS 2 Bluetooth single mode Module according BT-4.0.	ES
	Bluetooth® smart device without antenna	
	PAN1711	
ENW89835C3KF	Same as above without antenna including BlueRadios BR-SPP FW version.	ES
	Bluetooth® smart device without antenna	

Notes:

- (1) Abbreviation for Minimum Order Quantity (MOQ). The standard MOQ for mass production is 1500 pieces, fewer only on customer demand. Samples for evaluation can be delivered at any quantity via the distribution channels.
- (2) Samples are available on customer demand

25.1. INFORMATION REGARDING SOFTWARE VERSIONS

ENW89820/35A1KF:

The modules will be delivered with an empty flash. Customers need to program their own TI software in the production process. For details refer to the design guide.

ENW89820/35A3KF:

The modules are delivered with BlueRadios nBlue software. This software includes a bootloade and can be updated over the UART. For the latest revision refer to this link: http://blueradios.com/panasonic/index.php

Note: New customers seeking firmware and firmware support are required to register by providing an invoice number.

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26. ROHS A	ND REACH DE	CLARAT	ION						
	e declare to our b elatest official Rc			ed on declarati	ion of our suppliers	that this prod	luct		
Panason	asonic iic Industrial Devices Slov 616, 028 01 TRSTENA	akia s.r.o							
	1(0)43 5303 200 1(0)43 5303 207								
Dear	Customer,			Date	2: 20.11.2012				
Panas	onic Industrial De	vices Slova	kia s.r.o., guarante	e that:					
Direc	tive 1907/2006 (RE	ACH)							
(SVH) our pr Due to suppli inform	Substances from the candidate lists of so called "substances of very high concern" (SVHC) published by ECHA are regular monitored if SVHC substances are contained in our products above 0.1% (w/w). Due to the high complexity of these substance investigations covering all of our global suppliers, this process required some time. We will provide you with all substance information regarding our products base on information collected from our suppliers.								
manuf	sonic Industrial Des factured and deliver CSubstances:	vices Slova ed to your o	<i>kia s.r.o.</i> hereby de company have SVI	HC substances <	0.1% (w/w).				
	SVHC Candidate list SVHC Candidate list	2 2 3 4 5 6	(28/10/2008) (13/01/2010) (30/03/2010) (18/06/2010) (15/12/2010) (20/06/2011) (19/12/2011) (18/06/2012)	[15 Substance [12 Substance] [1 Substance] [8 Substances [8 Substances [7 Substances [20 Substance [13 Substance]	s]]] [s]				
Direc	tive 2011/65/EC (R	(oHS)							
follov maxin	onfirm that all proving substances white num concentration of - Lead and lead comp - Mercury and mercur - Chromium (VI), - PBB (polybrominat and a maximum conc - Cadmium and cadm less Modules (ENV	ich are ban of 0.1% by younds, iry compound ed biphenyl) o entration of 0 nium compou	ned by Directive 2 weight in homogen ls, category, PBDE (poly .01% by weight in hor nds.	2002/95/EC (Rol neous materials f brominated bipheny nogeneous material	HS) or if contain a for: I ether) category s for:				
Create:	Kostalikova	Check:	Firmentova	Approval:	Kashiwaya				
2.055.55 m 10	Alena		Viera		Shinichi S Kashiwy	-			

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27. DATA SHEET STATUS

This data sheet contains the final specification (RELEASE).

Panasonic reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

Please consult the most recently issued data sheet before initiating or completing a design.

Use this URL to search for the most recent version of this data sheet:

PAN172x Datasheet

28. HISTORY FOR THIS DOCUMENT

Revision	Date	Modification / Remarks
0.01	November 2011	1 st preliminary version.
0.02	November 2011	Deleted footnote in chapter 12.
1.00	April 2012	Released Version.
1.1	July 2012	Add chapter 25.1 Information regarding Software Versions. Link to LGA app note. Removed watermark. UART pinning for BR-SW version. I2C pinning for PAN1721 version. FCC, IC, IDs.
1.2	July 2012	Added remark "top view" for footprint. Corrected FCC ID to T7VPAN17. Change to the correct company name in footer.
1.3	Agust 2012	Change IC text in chapter 32.1 Change to the correct company name in footer. New format for chapter Related Documents
1.4	November 2012	Added some remarks to PAN1721 version. Added non antenna version part number to Ordering information.
1.5	December 2012	Added PAN1711 ES information
1.6	January 2013	Added dimensions and pinout for the non-antenna versions PAN171x.
1.7	January 2013	Minor changes in chapter 6, 31.4. Chapter 3 was included and chapter 34 BT Certificiation was added.
1.8	May 2013	Changed Block Diagram
1.9	August 2013	Included Crossreference for GPIOs to BlueRadios Pinout

29. RELATED DOCUMENTS

For an update, please search in the suitable homepage.

- [1] PAN172xETU Design-Guide http://www.pideu.panasonic.de/pdf/168ApplicationNote.pdf
- [2] Semiconductor Datasheet <u>CC2540 from Texas Instruments</u> <u>CC2541 from Texas Instruments</u>
- [3] Application Note Land Grid Array http://www.pideu.panasonic.de/pdf/184ext.pdf
- [4] REACH and RoHS Certificate http://www.pideu.panasonic.de/pdf/182ext2.jpg

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30. GENERAL INFORMATION

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This product description does not lodge the claim to be complete and free of mistakes. Please contact the related product manager in every case.

If we deliver ES samples to the customer, these samples have the status Engineering Samples. This means, the design of this product is not yet concluded. Engineering Samples may be partially or fully functional, and there may be differences to be published Data Sheet. Engineering Samples are not qualified and are not to be used for reliability testing or series production.

Disclaimer:

Customer acknowledges that samples may deviate from the Data Sheet and may bear defects due to their status of development and the lack of qualification mentioned above.

Panasonic rejects any liability or product warranty for Engineering Samples. In particular, Panasonic disclaims liability for damages caused by

- the use of the Engineering Sample other than for Evaluation Purposes, particularly the installation or integration in an other product to be sold by Customer,
- deviation or lapse in function of Engineering Sample,
- improper use of Engineering Samples.

Panasonic disclaimes any liability for consequential and incidental damages.

In case of any questions, please contact your local sales partner or the related product manager.

31. REGULATORY INFORMATION

31.1. FCC NOTICE



The devices PAN17xx, for details refer to Chapter 25, including the antennas, which are listed in 31.5, complies with Part 15 of the FCC Rules. The device meets the requirements for modular transmitter approval as detailed in FCC public Notice DA00-1407.transmitter Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) This device must accept any interference received, including interference that may cause undesired operation.

31.2. CAUTION



The FCC requires the user to be notified that any changes or modifications made to this device that are not expressly approved by Panasonic Industrial Devices Europe GmbH may void the user's authority to operate the equipment.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

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- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help

31.3. LABELING REQUIREMENTS



The Original Equipment Manufacturer (OEM) must ensure that FCC labeling requirements are met. This includes a clearly visible label on the outside of the OEM enclosure specifying the appropriate Panasonic FCC identifier for this product as well as the FCC Notice above. The FCC identifier is **FCC ID: T7VPAN17**. This FCC identifier is valid for all PAN17xx modules, for details, see the Chapter 25. Ordering Information.

In any case the end product must be labelled exterior with "Contains FCC ID: T7VPAN17"

31.4. ANTENNA WARNING

For the related part number of PAN17xx refer to Chapter 25. Ordering Information.

This devices are tested with a standard SMA connector and with the antennas listed below. When integrated in the OEMs product, these fixed antennas require installation preventing end-users from replacing them with non-approved antennas. Any antenna not in the following table must be tested to comply with FCC Section 15.203 for unique antenna connectors and Section 15.247 for emissions. The FCC identifier for this device with the antenna listed in item 1 are the same (FCC ID: T7VPAN17).

31.5. APPROVED ANTENNA LIST

Note: We are able to qualify your antenna and will add to this list as that process is completed.

Item	Part Number	Manufacturer	Frequency Band	Туре	Gain (dBi)
2	LDA212G3110K	Murata	2.4GHz	Chip-Antenna	+0.9

31.6. RF EXPOSURE PAN17XX



To comply with FCC RF Exposure requirements, the Original Equipment Manufacturer (OEM) must ensure that the approved antenna in the previous table must be installed.

The preceding statement must be included as a CAUTION statement in manuals for products operating with the approved antennas in the previous table to alert users on FCC RF Exposure compliance.

Any notification to the end user of installation or removal instructions about the integrated radio module is not allowed.

The radiated output power of PAN17xx with mounted ceramic antenna **(FCC ID: T7VPAN17)** is far below the FCC radio frequency exposure limits. Nevertheless, the PAN17xx shall be used in such a manner that the potential for human contact during normal operation is minimized.

End users may not be provided with the module installation instructions. OEM integrators and end users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

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32. INDUSTRY CANADA CERTIFICATION											
license: Manufa clarify a Users c This dev	PAN17xx is licensed to meet the regulatory requirements of Industry Canada (IC), license: IC: 216Q-PAN17 Manufacturers of mobile, fixed or portable devices incorporating this module are advised to clarify any regulatory questions and ensure compliance for SAR and/or RF exposure limits. Users can obtain Canadian information on RF exposure and compliance from <u>www.ic.gc.ca</u> . This device has been designed to operate with the antennas listed in Table 20 above, having a maximum gain of 0.9 dBi. Antennas not included in this list or having a gain greater than 0.9										
ohms. conjunc Due to t	strictly prohibite The antenna u tion with any oth he model size th isplayed on the	sed for this er antenna o ne IC identifie	transmitte r transmitter er is display	r must not ed in the in:	be co-loo stallation ir	cated or operation only a	ating in				
in 31.5, modular Operatio	ices PAN17xx, f complies with transmitt on is subject to ence, and (2)	Canada RSS er app the following This device	S-GEN Rul roval two condit must ac	es. The de as do ions: (1) Th	vice meets etailed is device r	s the requirem in RS may not cause e received, ir	ents for S-GEN. harmful				
The Ori met. Th appropr identifie the Cha In ar	5	Manufacture arly visible la IC identifier f 7. This IC ide g Information ne end	abel on the or this proc entifier is va	outside of t luct as well alid for all P.	he OEM ei as the IC	nclosure specif Notice above. odules, for deta	ying the The IC				
33. BLUETOOTH	IS IC: 216Q-PAN										
The Des	sign is listed as (Controller Sub	•		16552						
The mo	dule is listed as	EPL based o	n Texas Ins	struments Q	DID B0165	552.					
	To create an EPL, two Subsystems e.g. QDID: B016552 and QDID: B017183 (software stack) need to be combined.										

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34. EUROPEAN R&TTE DECLARATION OF CONFORMITY

Hereby, Panasonic Industrial Devices Europe GmbH, declares that the Bluetooth module PAN17xx and their versions is in compliance with the essential requirements and other relevant provisions of Directive 1999/5/EC. As a result of the conformity assessment procedure described in Annex III of the Directive 1999/5/EC, the end-customer equipment should be labelled as follows:

C€

PAN17xx and their versions in the specified reference design can be used in the following countries: Austria, Belgium, Cyprus, Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, Poland, Portugal, Slovakia, Slovenia, Spain, Sweden, The Netherlands, the United Kingdom, Switzerland, and Norway.

35.LIFE SUPPORT POLICY

This Panasonic product is not designed for use in life support appliances, devices, or systems where malfunction can reasonably be expected to result in a significant personal injury to the user, or as a critical component in any life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness. Panasonic customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panasonic for any damages resulting.